

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5199051

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHANG-MING WU	03/10/2014
WEI CHENG WU	02/10/2014
SHIH-CHANG LIU	02/10/2014
HARRY-HAK-LAY CHUANG	02/10/2014
CHIA-SHIUNG TSAI	02/10/2014
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Property Type	Number
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NAME OF SUBMITTER:	JAMES R. POTASHNIK
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DATE SIGNED:	10/22/2018

Total Attachments: 7

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U.S. Patent Appln. No.

Docket No. TSMCP375US

Filing Date

PATENT ASSIGNMENT

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AGREEMENT

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled
"SPLIT GATE MEMORY DEVICE AND METHOD OF FABRICATING THE SAME"

for which:

a non-provisional application for United States Letters Patent:

☒ was executed on even date preparatory to filing (each inventor should sign this
Assignment on the same day as he/she signs the Declaration and Power of
Attorney); or

☐ was filed on _____ and accorded U.S. Serial No. _____; or

☐ I hereby authorize and request my attorney associated with Customer No.
107476, to insert on the designated lines below the filing date and application
number of said application when known:

U.S. Serial No. _____,

filed on _____.

WHEREAS, ASSIGNEE (listed above), a corporation of the Republic of China is
desirous of acquiring the entire right, title and interest in and to the invention and in and to
any letters patent that may be granted therefore in the United States and in any and all
foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of
which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto
ASSIGNEE its successors and assigns, the entire right, title and interest in and to said
invention and improvements, said application and any and all letters patent which may be
granted for said invention in the United States of America and its territorial possessions and
in any and all foreign countries, and in any and all divisions, reissues, re-examinations and

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continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

✓ 3/10/2014
Date

✓ Chang-Ming-Wu
Name 1st Inventor Chang-Ming Wu

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2014.2.10
Wei Cheng Wu
Date

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Filing Date

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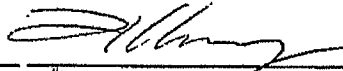
✓ 2.10.2014
Date

✓ Shih - chang Liu
Name 3rd Inventor Shih-Chang Liu

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Filing Date

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Name 4th Inventor Harry-Hak-Lay Chuang

U.S. Patent Appln. No.
Filing Date

TSMC Docket No. TSMC2013-1369

Docket No. TSMCP375US

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Date

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